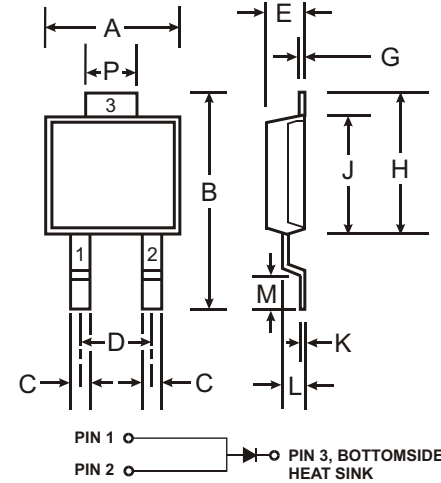


Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 2)**

Mechanical Data

- Case: POWERMITE 3, Molded Plastic
- Case Material: Molded Plastic: UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish).
- Polarity: See Diagram
- Marking: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



POWERMITE 3		
Dim	Min	Max
A	4.03	4.09
B	6.40	6.61
C	.889 NOM	
D	1.83 NOM	
E	1.10	1.14
G	.178 NOM	
H	5.01	5.17
J	4.37	4.43
K	.178 NOM	
L	.71	.77
M	.36	.46
P	1.73	1.83
All Dimensions in mm		

Note: Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current (See also Figure 5)	I _O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load	I _{FSM}	100 50	A
		@ T _C = 25 C @ T _C = 100 C	
Typical Thermal Resistance Junction to Soldering Point	R _{JS}	3.2	C/W
Operating Temperature Range	T _j	-55 to +125	C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25 C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	60			V	I _R = 0.2mA
Forward Voltage	V _{FM}		0.59 0.53 0.72 0.63	0.63 0.57 0.76 0.67	V	I _F = 3A, T _j = 25 C I _F = 3A, T _j = 125 C I _F = 6A, T _j = 25 C I _F = 6A, T _j = 125 C
Reverse Current (Note 1)	I _{RM}		2.0 0.6 2.5	200 20 150	A mA mA	T _j = 25 C, V _R = 60V T _j = 100 C, V _R = 60V T _j = 125 C, V _R = 60V
Total Capacitance	C _T		130		pF	f = 1.0MHz, V _R = 4.0V DC

Notes: 1. Short duration test pulse used to minimize self-heating effect.
2. RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see EU Directive Annex Note 7.

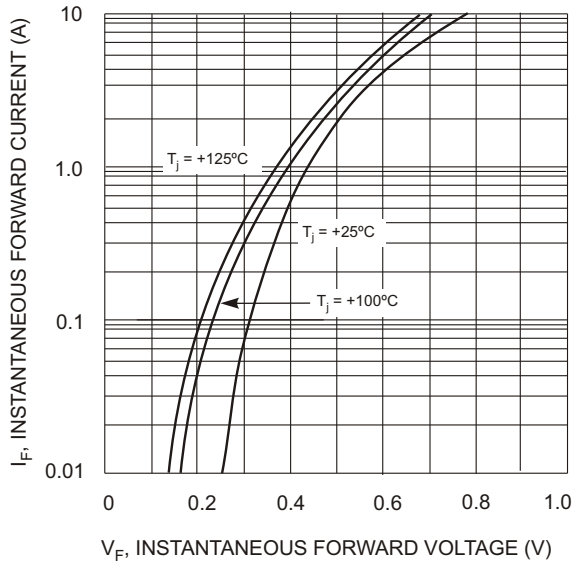


Fig. 1 Typ. Forward Characteristics

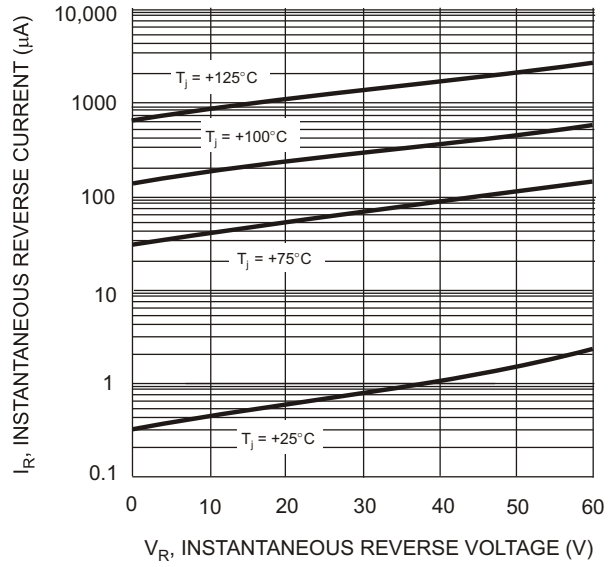


Fig. 2 Typical Reverse Characteristics

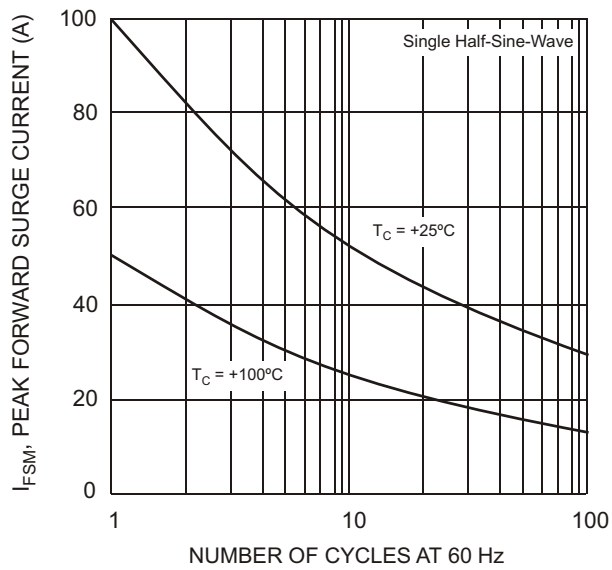


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

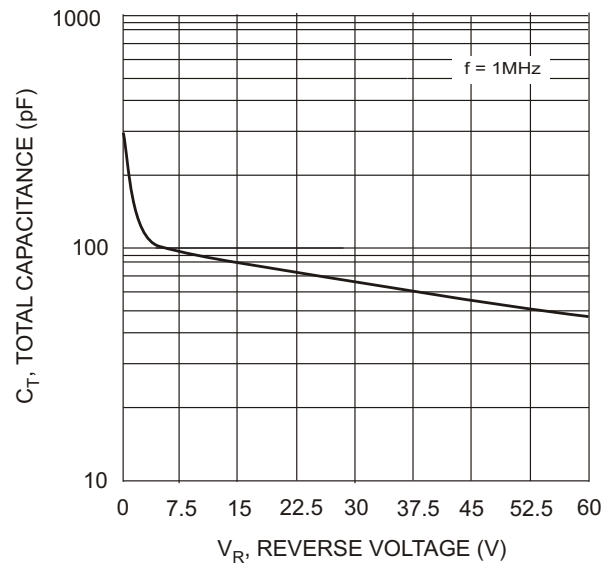
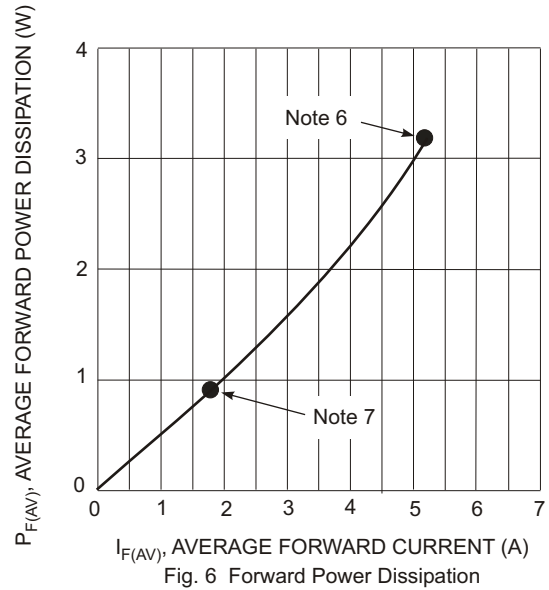
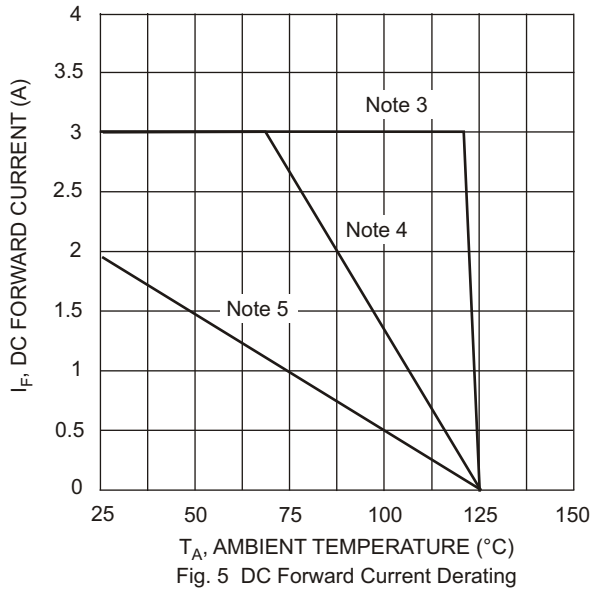


Fig. 4 Typical Capacitance vs. Reverse Voltage



- Notes:
3. $T_A = T_{SOLDERING\ POINT}$, $R_{JS} = 3.2\ C/W$, $R_{SA} = 0\ C/W$.
 4. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{JA} in range of 20-40°C/W.
 5. Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>. R_{JA} in range of 100-120°C/W.
 6. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4.
 7. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 5.

Ordering Information (Note 8)

Device	Packaging	Shipping
MBRM360-13-F	POWERMITE 3	5000/Tape & Reel

Notes: 8. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



MBRM360 = Product type marking code
 ⌋||| = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last digit of year ex: 02 for 2002
 WW = Week code 01 to 52
 (K) = Factory Designator

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